Docket No.: 3273-0208PUS1

(PATENT)

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of: Hisashi MAESHIMA, et al.

Application No.: 10/526,672 Confirmation No.: 3246

Filed: March 4, 2005 Art Unit: 1796

For: PROCESS FOR PREPARATION OF Examiner: Robert SELLERS ALICYCLIC DIEPOXY COMPOUNDS, CURABLE EPOXY RESIN COMPOSITIONS.

EPOXY RESIN COMPOSITIONS FOR THE ENCAPSULATION OF ELECTRONIC PARTS,

STABILIZERS FOR ELECTRICAL

INSULATING OILS, AND CASTING EPOXY RESIN COMPOSITIONS FOR ELECTRICAL

INSULATION

## **AMENDMENT UNDER 37 CFR 1.111**

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In reply to the Office Action dated December 10, 2007, the following amendments and remarks are respectfully submitted in connection with the above-identified application.

This reply includes:

Amendments to the specification;

Remarks; and

English language translation of priority document.